Transistors

# 2SD2185

## Silicon NPN epitaxial planar type

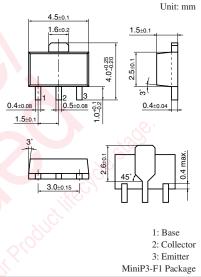
For low-frequency output amplification Complementary to 2SB1440

#### Features

- Low collector
- Mini Power and automat zine packing

<ul> <li>Low collector-emitter saturation v</li> <li>Mini Power type package, allowin and automatic insertion through t zine packing</li> <li>Absolute Maximum Rating</li> </ul>	ng downsi he tape pa	izing of the e acking and th		0.4±0.08 1.5±0.1	
Parameter	Symbol	Rating	Unit	-	
Collector-base voltage (Emitter open)	V <sub>CBO</sub>	50	V		
Collector-emitter voltage (Base open)	V <sub>CEO</sub>	50	V		
Emitter-base voltage (Collector open)	V <sub>EBO</sub>	5	V		
Collector current	I <sub>C</sub>	3	А		
Peak collector current	I <sub>CP</sub>	4	А		
Collector power dissipation *	P <sub>C</sub>	1	W	Marking	
Junction temperature	Tj	150	°C		
Storage temperature	T <sub>stg</sub>	-55 to +150	°C		





#### ymbol: 1H

Note) \*: Printed circuit board: Copper foil area of 1 cm<sup>2</sup> or more, and the board thickness of 1.7 mm for the collector portion

#### Electrical Characteristics $T_a = 25^{\circ}C \pm 3^{\circ}C$

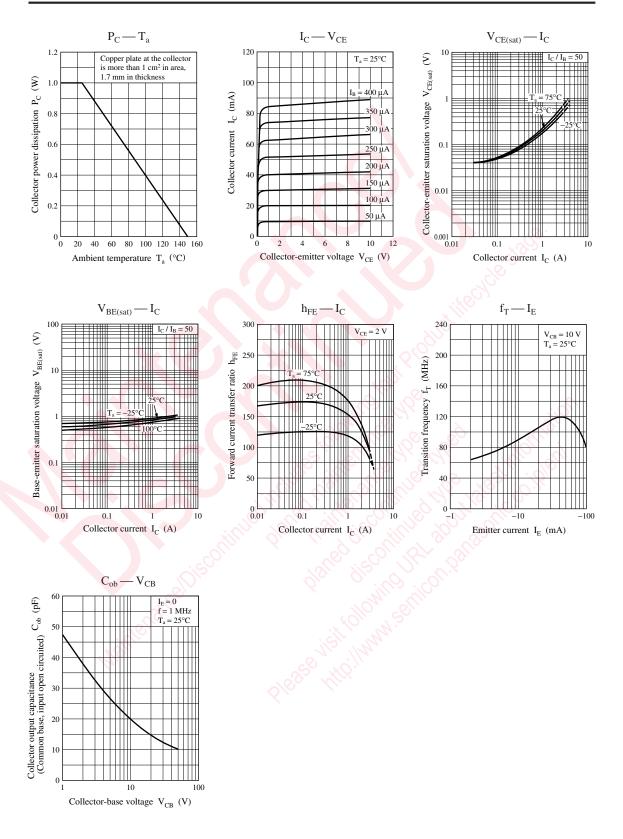
Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Collector-base voltage (Emitter open)	V <sub>CBO</sub>	$I_{\rm C} = 10 \ \mu A, I_{\rm E} = 0$	50			V
Collector-emitter voltage (Base open)	V <sub>CEO</sub>	$I_{\rm C} = 1 \text{ mA}, I_{\rm B} = 0$	50			V
Emitter-base voltage (Collector open)	V <sub>EBO</sub>	$I_{\rm E} = 10 \ \mu A, I_{\rm C} = 0$	5			V
Collector-base cutoff current (Emitter open)	I <sub>CBO</sub>	$V_{CB} = 20 \text{ V}, I_E = 0$			0.1	μΑ
Forward current transfer ratio	h <sub>FE1</sub> *	$V_{CE} = 2 V, I_C = 200 mA$	120		340	_
	h <sub>FE2</sub>	$V_{CE} = 2 V, I_C = 1.0 A$	80			
Collector-emitter saturation voltage	V <sub>CE(sat)</sub>	$I_{\rm C} = 1  \rm{A},  I_{\rm B} = 50  \rm{mA}$		0.15	0.30	V
Base-emitter saturation voltage	V <sub>BE(sat)</sub>	$I_{C} = 1 \text{ A}, I_{B} = 50 \text{ mA}$		0.85	1.20	V
Transition frequency	f <sub>T</sub>	$V_{CB} = 10 \text{ V}, I_E = -50 \text{ mA}, f = 200 \text{ MHz}$		120		MHz
Collector output capacitance (Common base, input open circuited)	C <sub>ob</sub>	$V_{CB} = 10 \text{ V}, I_E = 0, f = 1 \text{ MHz}$		20	35	pF

Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 measuring methods for transistors.

2. \*: Rank classification

Rank	R	S
h <sub>FE1</sub>	120 to 240	170 to 340

## **Panasonic**



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